

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

David R. Hembree

Serial No.: 10/624,332

Filed: July 22, 2003

For: CHIP ON BOARD AND HEAT SINK
ATTACHMENT METHODS

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May 16, 2007

**FEE ADDRESSEE FOR RECEIPT OF PTO NOTICES
RELATING TO MAINTENANCE FEES**

Mail Stop ISSUE FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

1. This letter is to specify that the FEE ADDRESSEE for this patent is:

Serial No. 10/624,332

MICRON TECHNOLOGY, INC.

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2. The Customer Number for the Fee Addressee is **26809**.
3. Any prior FEE ADDRESSEE for this patent is hereby revoked.
4. It is certified that the person whose signature appears below has the authority to change the FEE ADDRESSEE for this patent.

Respectfully submitted,



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Date: May 16, 2007
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